

Fuseholder Open Design, 5 x 20 / 6.3 x 32 mm, SMD, IEC: 500 VAC, UL/CSA: 250 VAC, Cover, IEC 60355-

1



500 VAC · 4 W/10 A (VDE) · 250 VAC · 16 A (UL/CSA)

**Description**

- Fuseholder for 500 VAC applications
- Meets the new requirements of IEC 60335-1 Ed. 4.0 for appliances in unattended use (clause 30.2.3). This includes the enhanced requirements of glow wire tests acc. to IEC 60695-2-11 to -13. Order number: 0031.8242 / 0031.8242.F1
- Fuse block accepts 5x20 or 6.3x32 fuse-links

Standards

- IEC 60127-6
- UL 512
- CSA C22.2 no. 39

Approvals

- VDE License Number: 40008993 (250V) + 40018378 (500V)
- UL File Number: E39328

Applications

- Equipment with three-phase supply (400 VAC)
- Industrial electronic


References

[General Product Information](#)
[Packaging Details](#)

Weblinks

[Approvals, RoHS, CHINA-RoHS, e-Store, SCHURTER-Stock-Check, Distributor-Stock-Check](#)

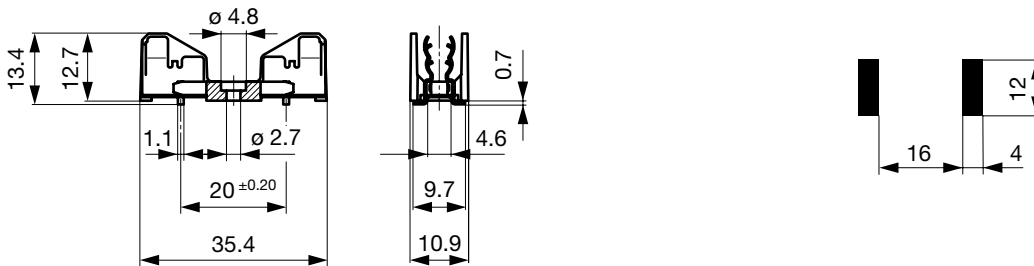
Technical Data

Fuse-Link	5 x 20 or 6.3 x 32 mm
Mounting	PCB
Fastening	Screw or Rivet
Terminal	Solder SMT
Rated Voltage	500VAC (VDE), 250VAC (UL/CSA)
Rated Current	10A (VDE), 16A (UL/CSA)
Rated Power Acceptance IEC	4 W / 10 A @ Ta 23 °C Admissible power acceptance at higher ambient temperature see derating curves
Degree of Protection	IP 00 / IP 20
Protection Class	Suitable for appliances with protection class I or II acc. to IEC 61140
Admissible Ambient Air Temp.	-40 °C to 85 °C
Climatic Category	40/085/21 acc. to IEC 60068-1
Material: Socket	Thermoplastic, black, UL 94V-0
Material: Terminals	Tin-Plated Copper Alloy
Unit Weight (Socket/Cap)	3.7 g
Storage Conditions	0 °C to 60 °C, max. 70% r.h.
Product Marking	 Type, Voltage Rating, Power Acc./Current Rating, Approvals

Soldering Methods	Reflow (see variants)
Solderability	245 °C / 3 sec acc. to IEC 60068-2-58, Test Td
Resistance to Soldering Heat	240 - 260 °C / 20 - 40 sec acc. to JEDEC J-STD-020C
Contact Resistance	< 5 mΩ at 20 mV
Dielectric Strength	> 3 kV between L-N (50 Hz; 1 min)
Impulse Withstand Voltage	> 4 kV between L-N
Insulation Resistance	> 10 MΩ between L-N (500 VDC; 1 min)
Overvoltage Category	I - III acc. to IEC 60664-1
Pollution Degree	2 acc. to IEC 60664-1
Resistance to Vibration	acc. to IEC 60068-2-6, test Fc

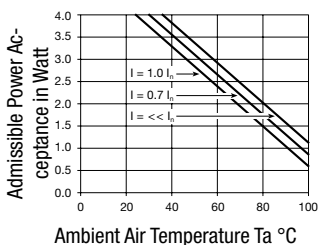
Dimensions

Length |-----| 35.4 mm



Solder pads

Derating Curves for Fuseholders



Variants

[Distributor-Stock-Check](#) | [SCHURTER-Stock-Check](#) | [e-Store](#)

Holder	Material	Reflow Condition	Remark	Order Number
•	Thermoplastic	(acc. to JEDEC J-STD-020C), $T_p=240 \pm 0/-5$ °C, $t_p = 20-40$ s	-	0031.8241
•	Spec. Thermoplastic 2	acc. to JEDEC J-STD-020C, $T_p=260 \pm 0/-5$ °C, $t_p = 20-40$ s	Approvals pending	0031.8242

Spec. thermoplastic 1 and 2 meet the new requirements of IEC 60335-1 Ed. 4.0 for appliances in unattended use (clause 30.2.3). This includes the enhanced requirements of glow wire tests acc. to IEC 60695-2-11 to -13.

Packaging Unit

Bulk 178 x 91 x 71 mm (100 pcs.)
xxxx.xxxx.F1 Bar Packaging (20x50 pcs.)

Accessory

Description



Cover OGD, OGD-SMD
Cover for Holder OGD, OGD-SMD

Reflow-Cover

0853.0917